



晶采光電科技股份有限公司
AMPIRE CO., LTD.

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	AC-162DYILY-70
APPROVED BY	
DATE	

☒Approved For Specifications

☐Approved For Specifications & Sample

AMPIRE CO., LTD.

**TOWER A, 4F, No.114, Sec. 1, HSIN-TAI 5th RD., HIS-CHIH,
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RECORD OF REVISION

Revision Date	Page	Contents
2003/12/5	-	New Release

1 FEATURES

- (1) Display format : 16 characters $\times$ 2 lines
- (2) Construction : STN LCD panel, Bezel, Zebra, Yellow-green LED back-light and PCB.
- (3) Display : STN, Yellow-green mode, Transflective , 6 o'clock view.
- (4) Controller : KS0066U or Equivalent.
- (5) 5V single power input.
- (6) Normal temperature type.
- (7) Excellent LC : VOP maintains at 5V for whole temp. range, no need extra temp. compensation circuit.

2 MECHANICAL DATA

Parameter	Stand Value	Unit
Dot size	0.55(W) $\times$ 0.65(H)	mm
Dot pitch	0.60(W) $\times$ 0.70(H)	mm
Character size	2.95(W) $\times$ 5.55(H)	mm
Viewing area	64.0(W) $\times$ 17.2(H)	mm
Module size (Array LED back-light)	84.0(W) $\times$ 44.0(H) $\times$ 14.5 max (T)	mm

3 ABSOLUTE MAXIMUM RATINGS

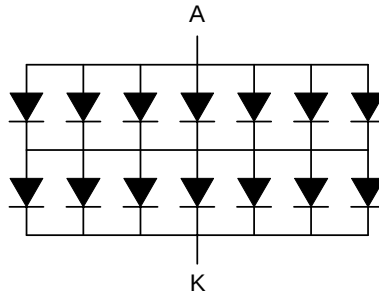
Parameter		Symbol	Min	Max	Unit
Logic Circuit Supply Voltage		VDD-VSS	-0.3	7.0	V
LCD Driving Voltage		VDD-VO	-0.3	10.0	V
Input Voltage		VI	-0.3	VDD+0.3	V
Normal temp. type	Operating Temp.	TOP	0	50	°C
	Storage Temp.	TSTG	-20	70	°C

4 ELECTRO-OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
----- Electronic Characteristics -----							
Logic Circuit Supply Voltage	VDD-VSS	--	2.7	--	5.5	V	
LCD Driving Voltage (STN)	VDD-VO	--	--	--	--	V	0 ~ 50 °C for Normal Temp. type
		0 °C	4.75	5.0	5.25		
		25 °C	4.75	5.0	5.25		
		50 °C	4.75	5.0	5.25		
		--	--	--	--		
Input Voltage	VIH	--	0.7 VDD	--	VDD	V	
	VIL	--	VSS	--	0.3 VDD	V	
Logic Supply Current	IDD	VDD = 5V	--	1.0	1.5	mA	
----- Optical Characteristics (STN) -----							
Contrast	CR	25°C	--	5	--		Note 1
Rise Time	tr	25°C	--	80	120	ms	Note 2
Fall Time	tf	25°C	--	150	300	ms	
Viewing Angle Range	θ f	25°C & CR≥2	--	40	--	Deg.	Note 3
	θ b		--	35	--		
	θ l		--	35	--		
	θ r		--	35	--		
Frame Frequency	fF	25°C	--	64	--	Hz	

-----Array type LED Back-light Characteristics -----							
Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
Forward Voltage	VF	--	--	4.05	4.3	V	Supply Voltage between A&K
Forward Current	IF	VF=4.05V	--	70	--	mA	
Bare LED Luminous intensity		VF=4.05V	--	100	--	cd/m ²	
LCM Luminous intensity		VF=4.05V	--	30	--	cd/m ²	

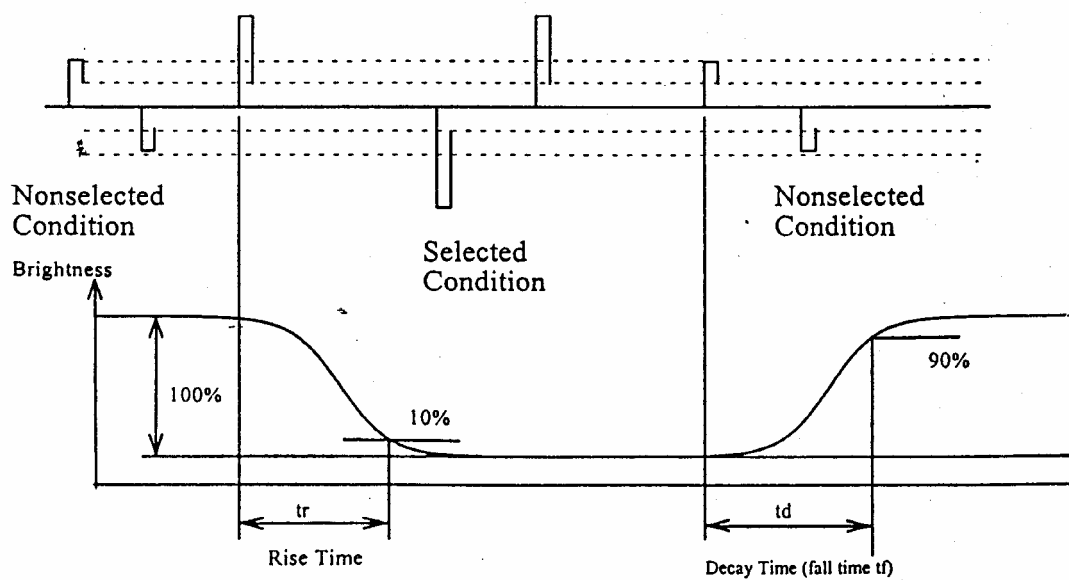
* LED Dice number = $2 \times 7 = 14$



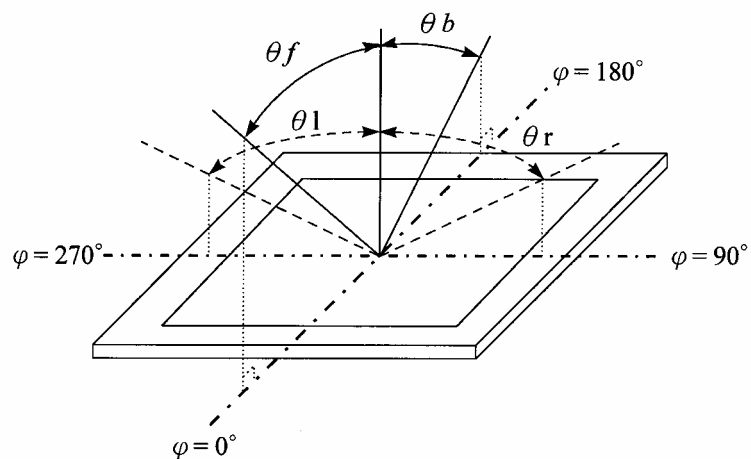
(NOTE 1) Contrast ratio :

$$CR = (\text{Brightness in OFF state}) / (\text{Brightness in ON state})$$

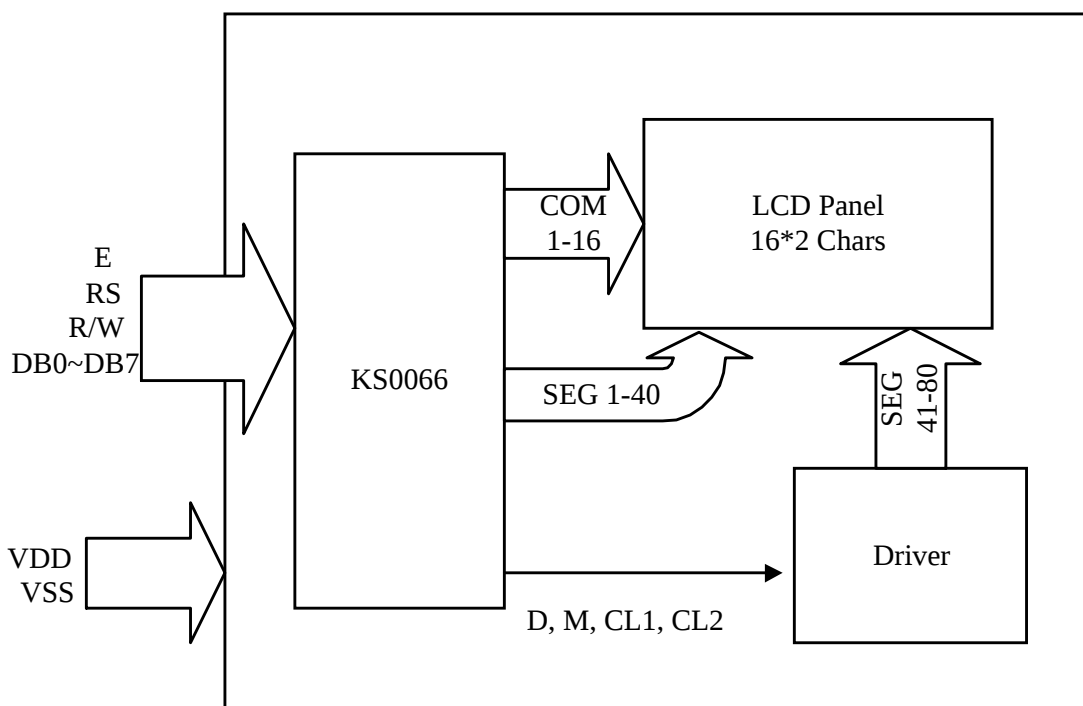
(NOTE 2) Response time :



(NOTE 3) Viewing angle

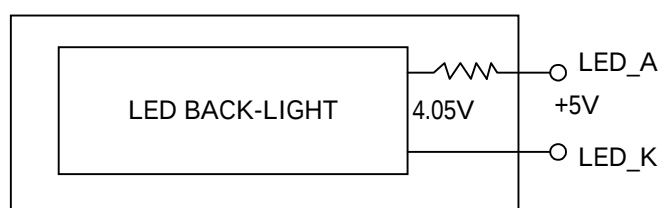
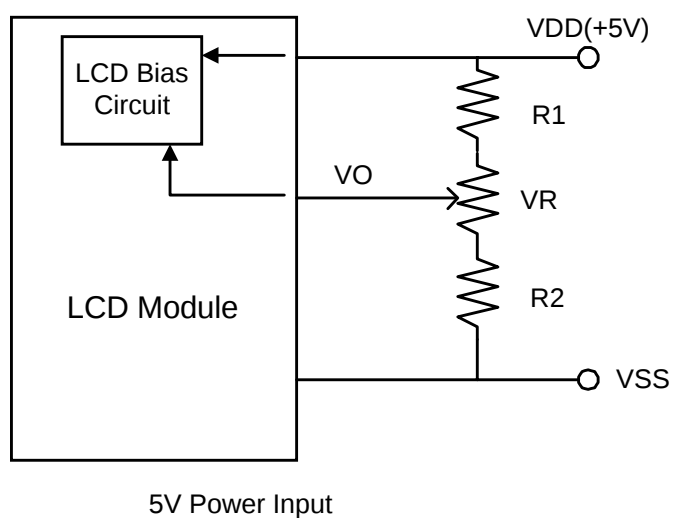


5 BLOCK DIAGRAM & INTERFACE



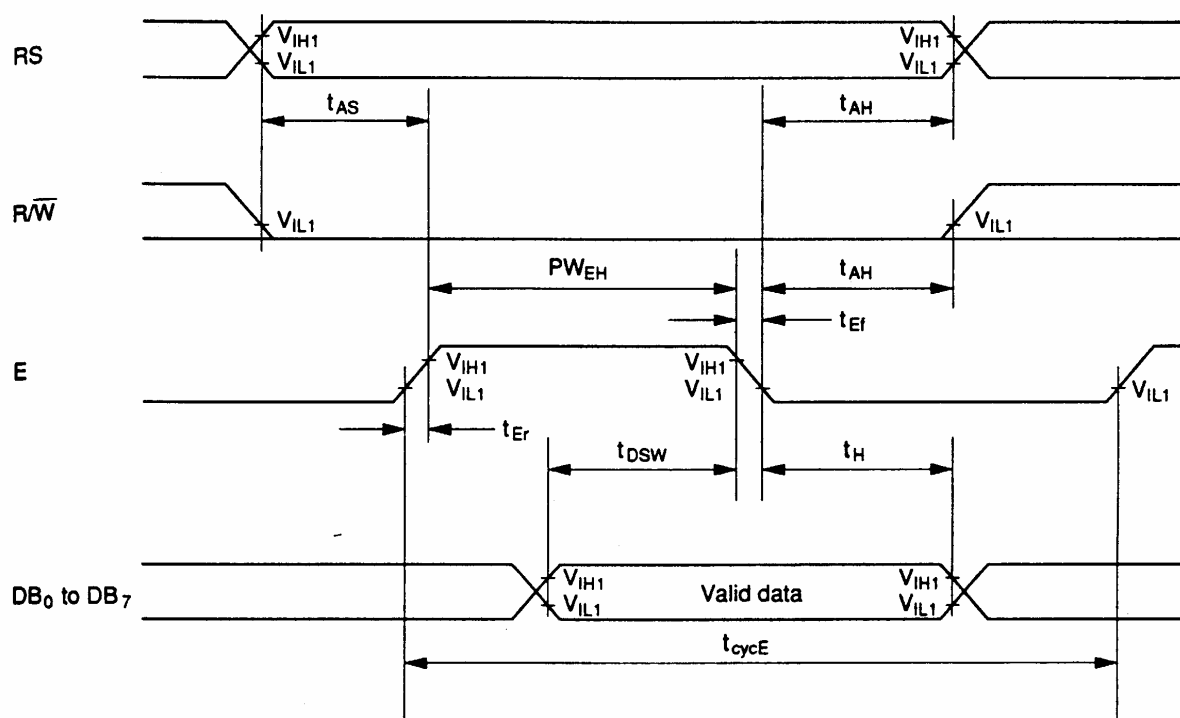
No.	Symbol	Function
1	VSS	Ground (0V)
2	VDD	Supply Voltage for Logic (+5V or +3.3V)
3	VO	Contrast Adjustment
4	RS	Data/Instruction Select
5	R/W	Read/Write Select
6	E	Enable Signal
7	DB0	Data Bus
8	DB1	Data Bus
9	DB2	Data Bus
10	DB3	Data Bus
11	DB4	Data Bus
12	DB5	Data Bus
13	DB6	Data Bus
14	DB7	Data Bus
15	LED_A	LED Power Supply + (5V)
16	LED_K	LED Power Supply - (5V)

6 POWER SUPPLY



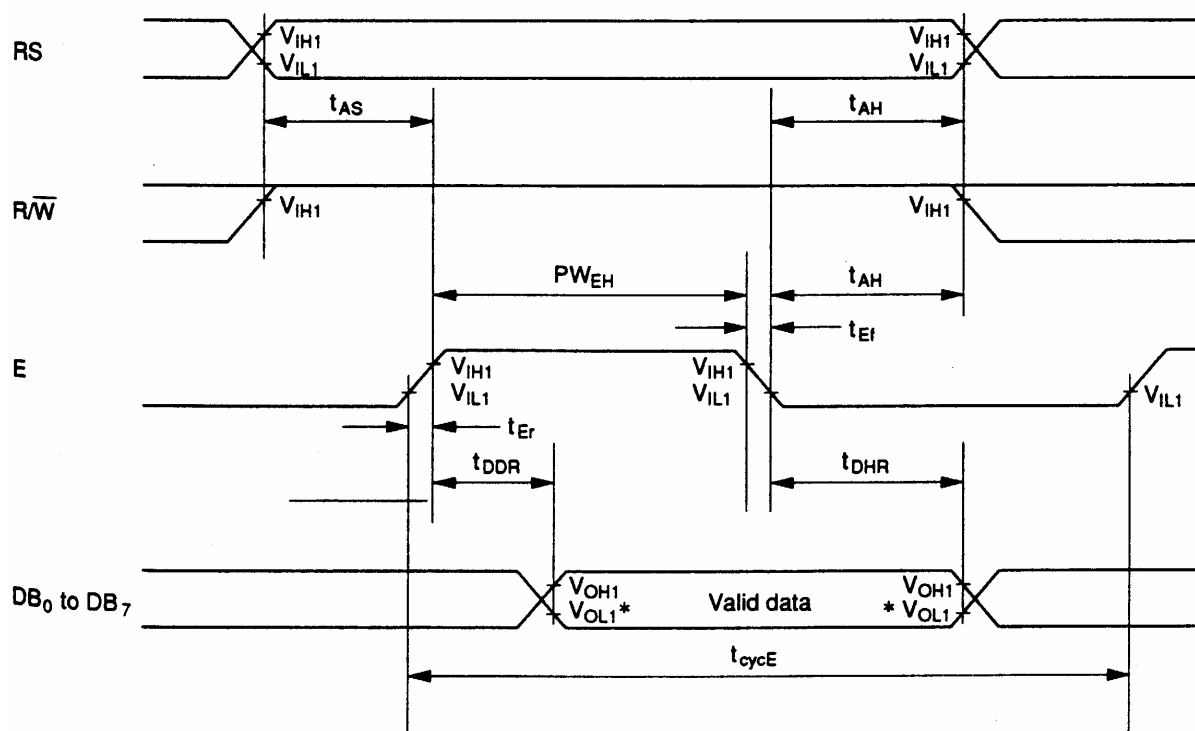
7 TIMING CHARACTERISTICS

Write Operation



Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	t_{cycE}	500	-	-	ns
Enable pulse width (high level)	PW_{EH}	220	-	-	
Enable rise/fall time	t_{E_r}, t_{E_f}	-	-	25	
Address set-up time (RS, R/W to E)	t_{AS}	40	-	-	
Address hold time	t_{AH}	10	-	-	
Data set-up time	t_{DSW}	60	-	-	
Data hold time	t_H	10	-	-	

Read Operation



Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	t_{cycE}	500	-	-	ns
Enable pulse width (high level)	PW_{EH}	220	-	-	
Enable rise/fall time	t_{Er}, t_{Ef}	-	-	25	
Address set-up time (RS, R/W to E)	t_{AS}	40	-	-	
Address hold time	t_{AH}	10	-	-	
Data delay time	t_{DDR}	--	-	120	
Data hold time	t_{DRH}	20	-	-	

8 FONT TABLE

Upper 4bit Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	HHHH
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
HHHH	(8)															

9 DD RAM ADDRESS

DIGIT	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
1 LINE	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
2 LINE	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

DD RAM Address

10 QUALITY AND RELIABILITY

10.1 TEST CONDITIONS

Tests should be conducted under the following conditions :

Ambient temperature : $25 \pm 5^{\circ}\text{C}$

Humidity : $60 \pm 25\% \text{ RH}$.

10.2 SAMPLING PLAN

Sampling method shall be in accordance with MIL-STD-105E, inspection level II, normal inspection, and single sampling plan tables for normal, tightened, and reduced inspection.

10.3 ACCEPTABLE QUALITY LEVEL

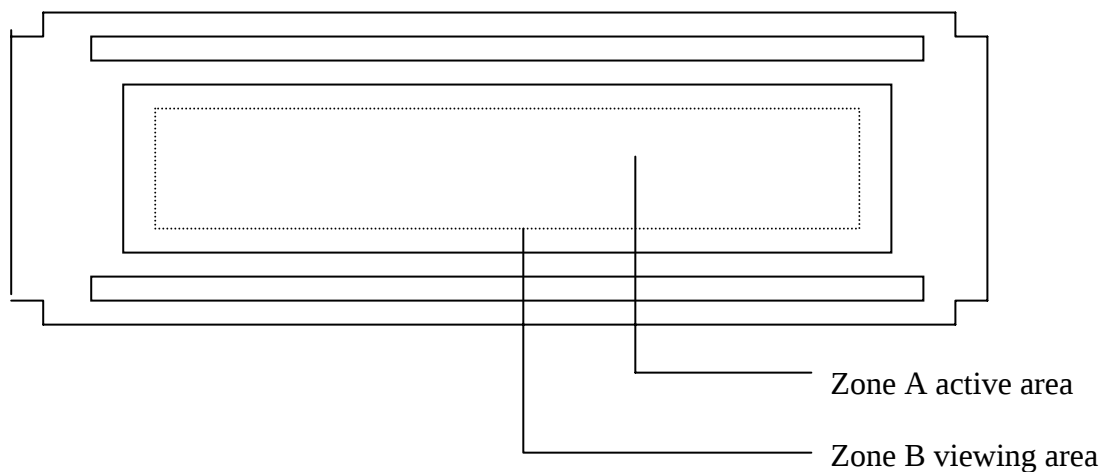
A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

10.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under fluorescent light. The inspection area of LCD panel shall be within the range of following limits.

10.5 INSPECTION QUALITY CRITERIA

Item	Description of defects			Class of Defects	Acceptable level (%)	
Function	Short circuit or Pattern cut			Major	0.65	
Dimension	Deviation from drawings			Major	1.5	
Black spots	Ave . dia . D	area A	area B	Minor	2.5	
	D≤0.2	Disregard				
	0.2<D≤0.3	3	4			
	0.3<D≤0.4	2	3			
	0.4<D	0	1			
Black lines	Width W, Length L		A	B	Minor	2.5
	W≤0.03		disregard			
	0.03<W≤0.05		3	4		
	0.05<W≤0.07 , L≤3.0		1	1		
	See line criteria					
Bubbles in polarizer	Average diameter D 0.2 < D < 0.5 mm for N = 4 , D > 0.5 for N = 1			Minor	2.5	
Color uniformity	Rainbow color or newton ring.			Minor	2.5	
Glass Scratches	Obvious visible damage.			Minor	2.5	
Contrast ratio	See note 1			Minor	2.5	
Response time	See note 2			Minor	2.5	
Viewing angle	See note 3			Minor	2.5	



10.6 RELIABILITY

Test Item	Test Conditions		Note
	Normal Temp. type	Extended Temp. type	
High Temperature Operation	50±3°C , t=96 hrs	70±3°C , t=96 hrs	
Low Temperature Operation	0±3°C , t=96 hrs	-20±3°C , t=96 hrs	
High Temperature Storage	70±3°C , t=96 hrs	80±3°C , t=96 hrs	1,2
Low Temperature Storage	-20±3°C , t=96 hrs	-30±3°C , t=96 hrs	1,2
Thermal Shock Test	-20°C ~ 25°C ~ 70°C 30 m in. 5 min. 30 min. (1 cycle) Total 5 cycle	-30°C ~ 25°C ~ 80°C 30 min. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2
Humidity Test	40 °C, Humidity 90%, 96 hrs		1,2
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis		2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions
(15-35°C , 45-65%RH).

Definitions of life end point :

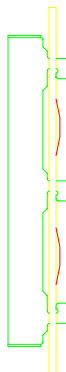
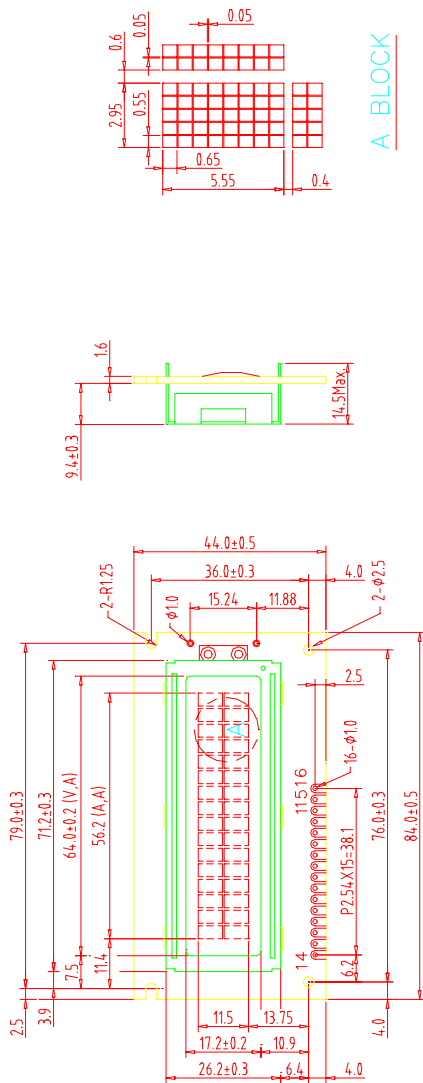
- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

11 HANDLING PRECAUTIONS

- (1) An LCD module is a fragile item and should not be subjected to strong mechanical shocks.
- (2) Avoid applying pressure to the module surface. This will distort the glass and cause a change in colour.
- (3) Under no circumstances should the position of the bezel tabs or their shape be modified.
- (4) Do not modify the display PCB in either shape or positioning of components.
- (5) Do not modify or move location of the zebra or heat seal connectors.
- (6) The device should only be soldered to during interfacing. Modification to other areas of the board should not be carried out.
- (7) In the event of LCD breakage and resultant leakage of fluid do not inhale, ingest or make contact with the skin. If contact is made rinse immediately.
- (8) When cleaning the module use a soft damp cloth with a mild solvent, such as Isopropyl or Ethyl alcohol. The use of water, ketone or aromatic is not permitted.
- (9) Prior to initial power up input signals should not be applied.
- (10) Protect the module against static electricity and observe appropriate anti-static precautions.

12 OUTLINE DIMENSION

REV	REVISION RECORD	DATE	NAME
1	NEW RELEASE	3-4-48	SNOW
2	Add 162DXX-40	11-24-41	SNOW
3	Add 162DXX-40	04-15-47	SNOW
4	Add 162DXX-75	06-21-47	SNOW



1	V _{SS}	9	DB2
2	V _{DD}	10	DB3
3	V ₀	11	DB4
4	RS	12	DB5
5	R/W	13	DB6
6	E	14	DB7
7	DB0	15	A
8	DB1	16	K

5	-60/-75
4	-50/-68/-502/-518/523
3	-00/-04/-08/-12/-24
2	-29/-53/-56/-505 (黑色高框)
1	-03/-16/-18/-25 (黑色高框)
No.	適用品號

[illegible]

13 PACKING METHOD

